# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MAKOTO SHIBUYA	05/15/2015
LUU NGUYEN	05/19/2015
NOBORU NAKANISHI	05/15/2015

## **RECEIVING PARTY DATA**

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BOULEVARD, MS 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14723122

## CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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TEXAS INSTRUMENTS INCORPORATED **Correspondent Name:** 

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ATTORNEY DOCKET NUMBER:	TI-75706
NAME OF SUBMITTER:	ANGELA DEOLIVEIRA
SIGNATURE:	/Angela DeOliveira/
DATE SIGNED:	08/20/2015

**Total Attachments: 2** 

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> **PATENT** REEL: 036383 FRAME: 0897 503445307

#### **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, MS 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	INTEGRATED CIRCUIT PACKAGE WITH SENSOR AND METHOD OF MAKING		
NONPROVISIONAL APPLICATION NO.	14/723,122	FILING DATE	May 27, 2015

SIGNATURE OF INVENTOR	* Makota Shilaya	ŧ
PRINTED NAME OF INVENTOR	Makoto Shibuya	
DATE	× 5/15 '15	
RESIDENCE (CITY AND STATE)	Beppu City, Japan	

Attorney Docket No. TI-75706

SIGNATURE OF INVENTOR	× Lu thank aguyen
PRINTED NAME OF INVENTOR	Luu Nguyen
DATE	× May 19, 2015
RESIDENCE (CITY AND STATE)	San Jose, California
SIGNATURE OF INVENTOR	× W & &
PRINTED NAME OF INVENTOR	Noboru Nakanishi
DATE	x 5/15 15
RESIDENCE (CITY AND STATE)	Beppu-Shi, Japan
SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	
DATE	
RESIDENCE (CITY AND STATE)	

After recording, return Assignment to:

Jonathon Scott Texas Instruments incorporated PO Box 655474, M/S 3999 Dallas, TX 75265

> PATENT REEL: 036383 FRAME: 0899

**RECORDED: 08/20/2015**